

S/N 10/081,818

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Jerome M. Eldridge et al.	Examiner:	Tu-Tu Ho
Serial No.:	10/081,818	Group Art Unit:	2818
Filed:	February 20, 2002	Docket No.:	1303.045US1
Customer No.:	73115	Confirmation No.:	3148
Title:	ATOMIC LAYER DEPOSITION OF METAL OXIDE AND/OR LOW ASYMMETRICAL TUNNEL BARRIER INTERPLAY INSULATORS		

COMMUNICATION RE: FEE ADDRESS

Mail Stop Issue Fee
Commissioner for Patents
P.O.Box 1450
Alexandria, VA 22313-1450

In response to the Notice of Allowance and Issue Fee Due, please record the Fee Address under the provisions of 37 CFR 1.363 as the following:

Customer Number 26809

which is associated with Micron Technology, Inc..

Please direct any inquiries to the undersigned attorney at (612) 349-9587.

Respectfully submitted,

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.
P.O. Box 2938
Minneapolis, MN 55402
(612) 349-9587

Date

6 Nov. '08

By



Timothy B. Clise
Reg. No. 40,957

TBC:CMG:kerl

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is filed using the USPTO's electronic filing system EFS-Web, and is addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 7 day of November, 2008.

Name

KATHLEEN E. ROTHACK

Signature

